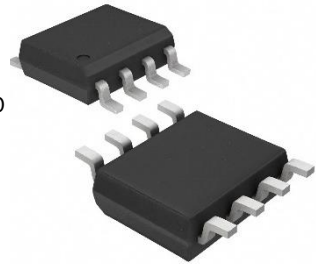


HX13082-S bus transceiver

The HX13082-S is a high-speed RS485/RS-422 transceiver circuit that supports +5V power supply with half-duplex functionality. The interior contains one driver and one receiver, which can achieve a transfer rate of up to 10Mbps. The circuit has $\pm 15\text{KV}$ ESD protection function, which can effectively prevent the damage of electrostatic discharge to the chip. Both the driver and receiver have enable pins (DE and RE) that drive and receive outputs in a high resistance state when the enable pins are off. In addition, the HX13082-S has a fail-safe circuit that ensures that the output remains correct when the receiver input is open or short-circuited. The input impedance of the receiver is 1/8 unit load, allowing up to 256 transceivers to be attached to the same bus.



SOP-8

Peculiarity

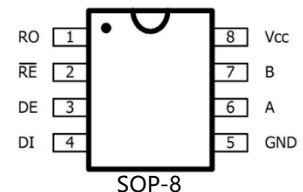
- Three-state output
- Electrostatic protection (ESD) : A/B $\pm 15\text{KV}$, in line with the human body mode (HBM) standard
- The bus allows up to 256 transceivers to be attached
- Strong swing rate limits help achieve error-free data transmission
- SOP8 package.

Apply

- Industrial control
- RS485/RS422 port
- Industrial motor drive
- Ammeter
- Automated heating, ventilation and air conditioning (HVAC) systems

Chip pin description

ID	Name	Feature
1	RO	Receiver data output
2	$\overline{\text{RE}}$	Receiver output enables the low level to be active, and the receive output is high when it is high
3	DE	Send enable end: The high level is valid. When DE is low, the send output is high
4	DI	Driver data entry
5	GND	Ground
6	A	Driver data output receiver data input
7	B	Driver data output receiver data input
8	Vcc	Power source



Drive truth table

Input	Enable	exportation	
DI	DE	A	B
H	H	H	L
L	H	L	H
X	L	Z	Z

Receiver truth table

Input			exportation
$\overline{\text{RE}}$	DE	A-B	RO
L	X	$\geq -50\text{mV}$	H
L	X	$\leq -200\text{mV}$	L
L	X	Open a way	H
L	X	short-circuit	H
H	H	X	Z
H	L	X	Z

Dc electrical parameter							
Limiting parameter							
Symbol	Parameter name	Min	Max	Unit			
VCC	Supply voltage		+6.0	V			
DE, RE	Control input voltage	-0.5	+6.0	V			
DI	Drive input voltage	-0.5	+6.0	V			
A,B	Drive output voltage/receive input voltage	-7.0	+12.0	V			
RO	Receiving output voltage	-0.3	V _{CC} +0.3	V			
TSTG	Storage temperature range	-55	+150	°C			
TOP	Operating temperature range	-40	+85	°C			
TMOP	Maximum operating temperature range	-55	+125	°C			
P _D	SOP-8 (+70°C or above)		470	mW			
T _L	Solder temperature (10 seconds)		+300	°C			
Dc characteristics (if not specified Vcc=5V±5%, TA=25°C) 2							
Argument	Symbol	Test condition		Min	Typ	Max	Unit
Operating voltage range	V _{CC}			4.5		5.5	V
Driver differential output (no load)	VOD1	-		-		5	V
Differential driver output (with load)	VOD2	R=54Ω or R=27Ω 图 1		1.5		-	V
Differential output voltage of the driver ¹	ΔV _{OD}			-		0.2	V
Driver common-mode output voltage	VOC			1		3	V
The amplitude of variation of the driver's common mode output voltage ¹	ΔV _{OC}					0.2	V
Input high voltage	V _{IH}	DE,RE ,DI		2			V
Input undervoltage	V _{IL}	DE,RE ,DI				0.8	V
Input current	I _{IIN1}	DE,RE ,DI				±2	uA
Input current (A,B)	I _{IIN2}	DE=0V,V _{CC} =5V	V _{IN} =5V		40	90	uA
			V _{IN} =0V		60	100	
Receiver differential input threshold voltage	V _{TH}	-7V ≤V _{CM} ≤ +12V		-		-50	mV
Receiver input lag	ΔV _{TH}			200	25		mV
Receiver output high level	V _{OH}	I _O = -8mA		4			V
Receiver output low level	V _{OL}	I _O =8mA				0.4	V
Receiver end three-state (high resistance) output current	I _{IOZR}	0.4V ≤V _O ≤2.4V				1	uA
Receiver input impedance	R _{IN}	-7V ≤V _{CM} ≤ +12V		96			kΩ
No load operating current	I _{CC}	no-load RE=DI=GND or V _{CC}	DE = V _{CC}		480	600	uA
			DE=GND		450	600	uA
Receiver output short-circuit current	I _{IOSR}	0V ≤V _{RO} ≤V _{CC}				95	mA
ESD protection		A/B ESD protection between human body modes		±8	±15		kV
Switch characteristics are not specified Vcc=5V±5%, TA=25°C							
Argument	Symbol	Test condition		Min	Typ	Max	Unit
Drive input to output	t _{DPLH}	R _{DIFF} =50Ω		250		1000	nS
	t _{DPHL}			250		1000	nS
Driver output offset t _{DPLH} – t _{DPHL}	t _{DSKEW}	C _{L1} =C _{L2} =100Pf			-3	±100	nS
Drive rise and fall time	t _{DR}	Figure 3, 5		200		750	nS
	t _{DF}			200		752	nS
The drive is enabled to output high	t _{DZH}	C _L 00pF Figure 4,6S2 is closed				2500	nS
The drive is enabled to low output	t _{DZL}	C _L =100pF Figure 4,6S1 is closed				2500	nS
Drive from low to off	t _{DLZ}	C _L =15pF Figure 4,6S1 is closed				100	nS
Drive from high to off	t _{DHZ}	C _L =15pF Figure 4,6S2 is closed				100	nS
Receiver input to output	t _{RPLH}	V _{ID} ≥2.0V;V _{ID} Rise and fall time ≤15nS Figure 7,9				200	nS
	t _{RPHL}					200	nS
Differential receiver migration	t _{RSKEW}				3	±30	nS
The receiver is enabled to low output	t _{RZL}	C _L =100pF Figure 2,8			20	50	nS
The receiver is enabled to the output as high	t _{RZH}	C _L =100pF Figure 2,8			20	50	nS
Receiver from low to off	t _{RLZ}	C _L =100pF Figure 2,8			20	50	nS
Receiver from high to off	t _{RHZ}	G=100pF Figure 2,8			20	50	nS

Maximum data speed	fMAX		250	500		Mbps
Communication bit error rate		Communication rate 250kbps			10^{-7}	

Note: 1 VOD and VOC indicate the amount of change in VOD and VOC, respectively, when DI changes.
2 The current is positive when it flows into the device and negative when it flows out of the device.
Unless otherwise specified, all voltages are ground reference points.

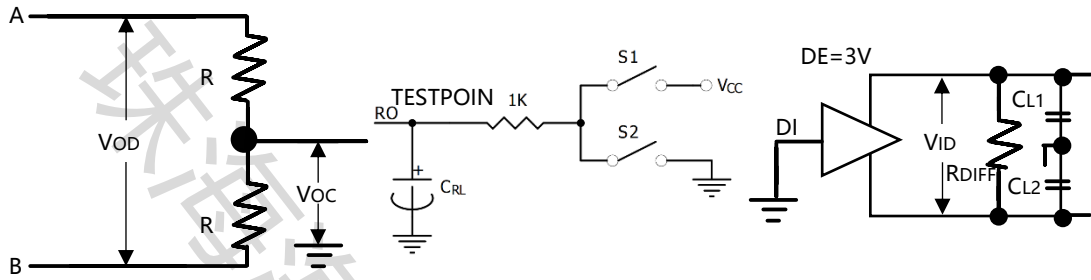


Figure 1 Driver DC characteristic test load

Figure 2 Receiver enable/Off switch characteristic test load

Figure 3. Driver switch characteristic test circuit

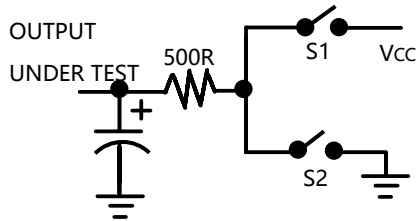


Figure 4 Driver enable/Off switch characteristic test load

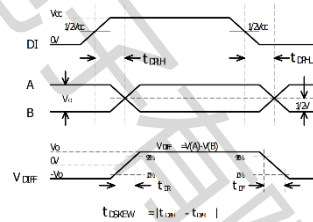


Figure 5 Transmission rate of the drive system in the whole system

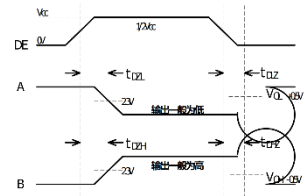
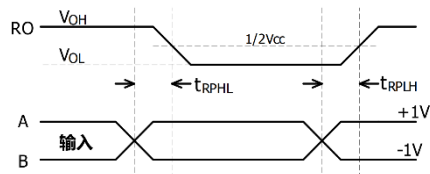


Figure 6 Drive enable/disable sequence



c7 Receiver transmission delay c

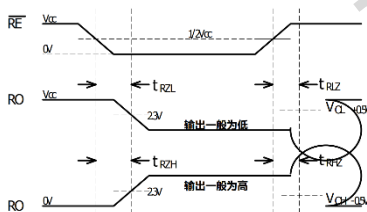


Figure 8 Receiver on/Off sequence

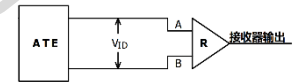
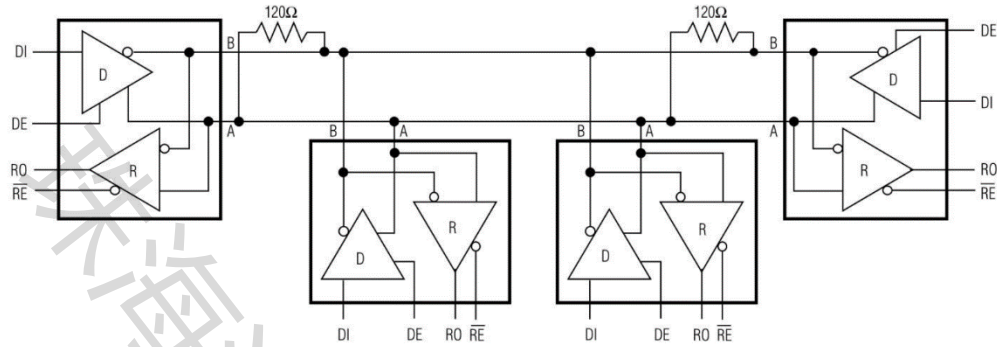


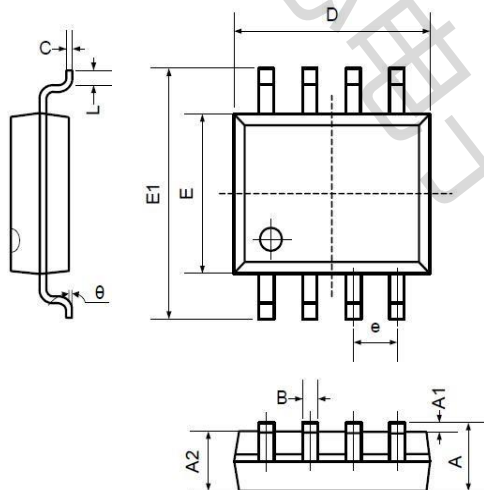
Figure 9 Receiver transmission delay test electrical

Typical application diagram

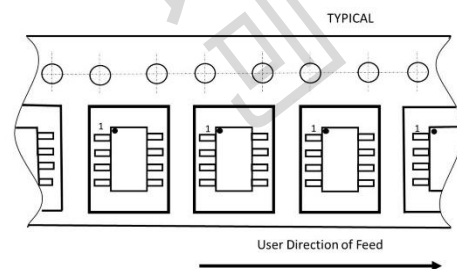
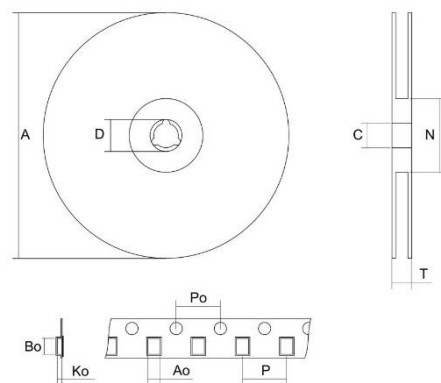


Packaging

SOP8 (Package Outline Dimensions)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
B	0.330	0.510	0.013	0.020
C	0.190	0.250	0.007	0.010
D	4.780	5.000	0.188	0.197
E	3.800	4.000	0.150	0.157
E1	5.800	6.300	0.228	0.248
e	1.270TYP		0.050TYP	
L	0.400	1.270	0.016	0.050
θ	0°		8°	



Packing method	Quantity
Braid	2500PCS/Disk